

## PUBLICATIONS

The conference organizers will provide a Book of Abstracts on USB including all submitted contributions. For each text one page A5 is allocated.

The poster size is A0 in portrait format (approximately 80 cm x 110 cm).

The ICT2015 proceedings will be published as a special issue of the Journal of Electronic Materials (JEM). The deadline for the submission of manuscripts is May 15, 2015.

Details for the preparation of abstracts, posters and proceeding contributions, templates and instructions as well as information about awards are available at the conference website.

## SCIENTIFIC ORGANIZATION

Max-Planck-Institut für Chemische Physik fester Stoffe  
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**MAX-PLANCK-INSTITUT**  
FÜR CHEMISCHE PHYSIK FESTER STOFFE

## DATES

Early registration April 7, 2015  
Abstract submission April 7, 2015  
Article submission May 15, 2015

The conference fee for participants amounts to 700,00 Euro before April 7th and 820,00 Euro thereafter. The conference fee for students is 380,00 Euro before April 7th and 440,00 Euro thereafter.

## REGISTRATION, EXHIBITION, SPONSORING

Intercom Dresden GmbH  
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## CALL FOR ABSTRACTS AND PAPERS SECOND CIRCULAR



## 34<sup>TH</sup> ANNUAL INTERNATIONAL CONFERENCE ON THERMOELECTRICS (ICT 2015)

AND

## 13<sup>TH</sup> EUROPEAN CONFERENCE ON THERMOELECTRICS (ECT 2015)

JUNE 28<sup>TH</sup> – JULY 2<sup>ND</sup>, 2015  
DRESDEN, GERMANY

[WWW.CPFS.MPG.DE/ICT2015](http://WWW.CPFS.MPG.DE/ICT2015)

## SCOPE

The ICT & ECT 2015 conference is organized under the auspices of the International and European Thermoelectrics Societies and will offer an international forum for scientific exchange on thermoelectricity. The sessions will cover all aspects from:

- materials design
- synthesis and characterization
- application issues and modules.

Up to 200 oral presentations include comprehensive contributions by invited speakers. In addition, 2 poster sessions will give the opportunity for informal discussions on specific issues. An exhibition of relevant equipment will be offered.

## CONFERENCE VENUE

Maritim Hotel & International Congress Center Dresden  
Ostra-Ufer 2/Devrientstr. 10-12  
01067 Dresden, Germany  
[www.dresden-congresscenter.de](http://www.dresden-congresscenter.de)



## CONFIRMED INVITED TALKS

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